

## Kelington wins RM108m job for bulk gas system at Singapore memory chip plant

By Choy Nyen Yiau / theedgemalaysia.com

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KUALA LUMPUR (Sept 22): Kelington Group Bhd (KGB) said on Monday it has secured a contract worth S\$33 million (RM108 million) to undertake engineering works at an advanced packaging facility project in Singapore.

In a filing with Bursa Malaysia, the group said the contract was awarded to its wholly-owned subsidiary, Kelington Engineering (S) Pte Ltd (KESG), by a turnkey engineering specialist. The main contractor's name was not disclosed.

Under the deal, KESG will be responsible for the bulk gas distribution piping system for the facility, which is being developed for a leading global memory chip manufacturer.

The project will commence immediately and is slated for completion by December 2026, upon the issuance of the final completion certificate by the project owner.

KGB said the contract is expected to contribute positively to its earnings and net assets for the financial years ending Dec 31, 2025, and Dec 31, 2026.

Kelington is an integrated engineering solutions provider specialising in ultra-high purity (UHP) gas and chemical delivery systems, mechanical process engineering, and mechanical and electrical systems.

Earlier this month, the company signed six framework agreements for its upcoming semiconductor hook-up project in Dresden, Germany, with a potential contract value of up to €50 million (RM247 million).

The agreements are to provide hook-up services for an unnamed multinational semiconductor client.

At the close of trading on Monday, shares in Kelington fell five sen or 0.9% to RM5.29, valuing the group at RM4.09 billion. Year to date, the counter has gained more than 48%.

*Read also:*

[\*Kelington inks framework deals worth up to RM247 mil for upcoming semiconductor plant hook-up job in Germany\*](#)

**Edited By** Isabelle Francis